



**Advanced Power
Electronics Corp.**

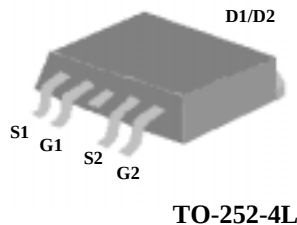
AP4578GH

Pb Free Plating Product

N AND P-CHANNEL ENHANCEMENT

MODE POWER MOSFET

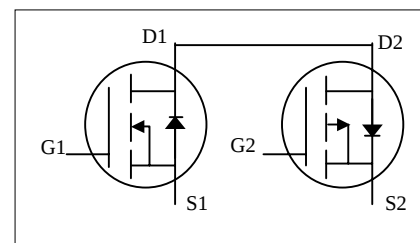
- ▼ Simple Drive Requirement
- ▼ Good Thermal Performance
- ▼ Fast Switching Performance



Description

The Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

N-CH	BV_{DSS}	60V
	$R_{DS(ON)}$	72m Ω
	I_D	9A
P-CH	BV_{DSS}	-60V
	$R_{DS(ON)}$	125m Ω
	I_D	-6A



Absolute Maximum Ratings

Symbol	Parameter	Rating		Units
		N-channel	P-channel	
V_{DS}	Drain-Source Voltage	60	-60	V
V_{GS}	Gate-Source Voltage	± 25	± 25	V
$I_D@T_C=25^\circ\text{C}$	Continuous Drain Current ³	9	-6	A
$I_D@T_C=100^\circ\text{C}$	Continuous Drain Current ³	6	-4	A
I_{DM}	Pulsed Drain Current ¹	30	-30	A
$P_D@T_C=25^\circ\text{C}$	Total Power Dissipation	8.9		W
	Linear Derating Factor	0.07		W/ $^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150		$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150		$^\circ\text{C}$

Thermal Data

Symbol	Parameter	Value	Units
Rthj-c	Thermal Resistance Junction-case ³	Max. 14	$^\circ\text{C}/\text{W}$
Rthj-a	Thermal Resistance Junction-ambient ³	Max. 110	$^\circ\text{C}/\text{W}$



AP4578GH

N-CH Electrical Characteristics@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	60	-	-	V
ΔBV _{DSS} /ΔT _j	Breakdown Voltage Temperature Coefficient	Reference to 25°C, I _D =1mA	-	0.05	-	V/°C
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V, I _D =5A	-	-	72	mΩ
		V _{GS} =4.5V, I _D =3A	-	-	90	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	1	-	3	V
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =5A	-	8	-	S
I _{DSS}	Drain-Source Leakage Current (T _j =25°C)	V _{DS} =60V, V _{GS} =0V	-	-	10	uA
	Drain-Source Leakage Current (T _j =150°C)	V _{DS} =48V, V _{GS} =0V	-	-	25	uA
I _{GSS}	Gate-Source Leakage	V _{GS} =±25V	-	-	±100	nA
Q _g	Total Gate Charge ²	I _D =5A	-	9	15	nC
Q _{gs}	Gate-Source Charge	V _{DS} =48V	-	2	-	nC
Q _{gd}	Gate-Drain ("Miller") Charge	V _{GS} =4.5V	-	5	-	nC
t _{d(on)}	Turn-on Delay Time ²	V _{DS} =30V	-	7	-	ns
t _r	Rise Time	I _D =1A	-	5	-	ns
t _{d(off)}	Turn-off Delay Time	R _G =3.3Ω, V _{GS} =10V	-	21	-	ns
t _f	Fall Time	R _D =30Ω	-	5	-	ns
C _{iss}	Input Capacitance	V _{GS} =0V	-	750	1200	pF
C _{oss}	Output Capacitance	V _{DS} =25V	-	80	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	60	-	pF
R _g	Gate Resistance	f=1.0MHz	-	1.5	2.3	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V _{SD}	Forward On Voltage ²	I _S =5A, V _{GS} =0V	-	-	1.2	V
t _{rr}	Reverse Recovery Time	I _S =5A, V _{GS} =0V	-	33	-	ns
Q _{rr}	Reverse Recovery Charge	dI/dt=100A/μs	-	55	-	nC

**P-CH Electrical Characteristics@T_j=25°C(unless otherwise specified)**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250uA	-60	-	-	V
ΔBV _{DSS} /ΔT _j	Breakdown Voltage Temperature Coefficient	Reference to 25°C, I _D =-1mA	-	-0.04	-	V/°C
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =-10V, I _D =-3A	-	-	125	mΩ
		V _{GS} =-4.5V, I _D =-2A	-	-	150	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250uA	-1	-	-3	V
g _{fs}	Forward Transconductance	V _{DS} =-10V, I _D =-3A	-	5	-	S
I _{DSS}	Drain-Source Leakage Current (T=25°C)	V _{DS} =-60V, V _{GS} =0V	-	-	-10	uA
	Drain-Source Leakage Current (T=150°C)	V _{DS} =-48V, V _{GS} =0V	-	-	-25	uA
I _{GSS}	Gate-Source Leakage	V _{GS} =±25V	-	-	±100	nA
Q _g	Total Gate Charge ²	I _D =-3A	-	13	21	nC
Q _{gs}	Gate-Source Charge	V _{DS} =-48V	-	3	-	nC
Q _{gd}	Gate-Drain ("Miller") Charge	V _{GS} =-4.5V	-	6	-	nC
t _{d(on)}	Turn-on Delay Time ²	V _{DS} =-30V	-	11	-	ns
t _r	Rise Time	I _D =-1A	-	5	-	ns
t _{d(off)}	Turn-off Delay Time	R _G =3.3Ω, V _{GS} =-10V	-	35	-	ns
t _f	Fall Time	R _D =30Ω	-	7	-	ns
C _{iss}	Input Capacitance	V _{GS} =0V	-	1030	1650	pF
C _{oss}	Output Capacitance	V _{DS} =-25V	-	90	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	75	-	pF
R _g	Gate Resistance	f=1.0MHz	-	5	7.5	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V _{SD}	Forward On Voltage ²	I _S =-3A, V _{GS} =0V	-	-	-1.2	V
t _{rr}	Reverse Recovery Time	I _S =-3A, V _{GS} =0V	-	42	-	ns
Q _{rr}	Reverse Recovery Charge	dI/dt=-100A/μs	-	82	-	nC

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse width ≤300us , duty cycle ≤2%.
- 3.N-CH , P-CH are same .



AP4578GH

N-Channel

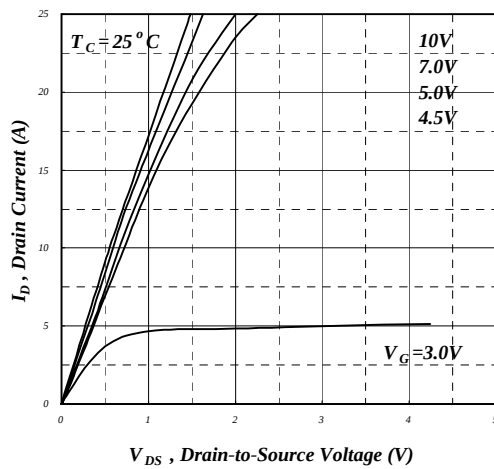


Fig 1. Typical Output Characteristics

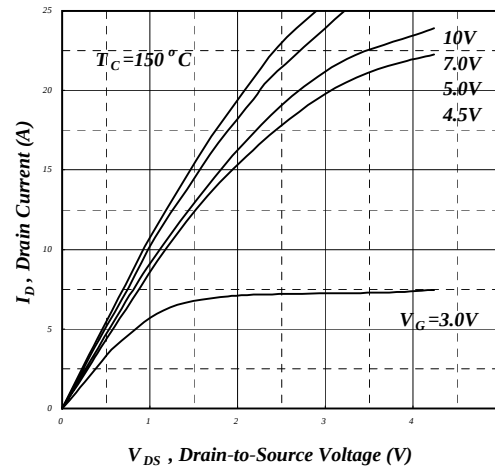


Fig 2. Typical Output Characteristics

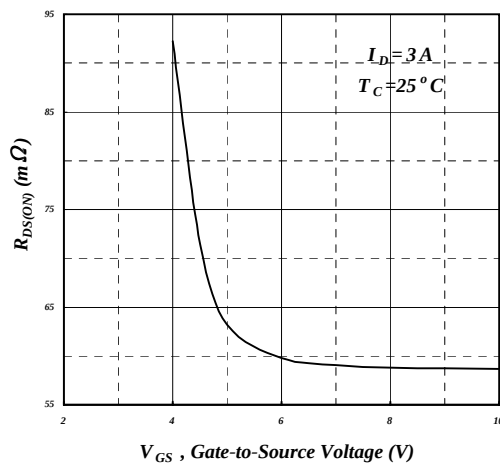


Fig 3. On-Resistance v.s. Gate Voltage

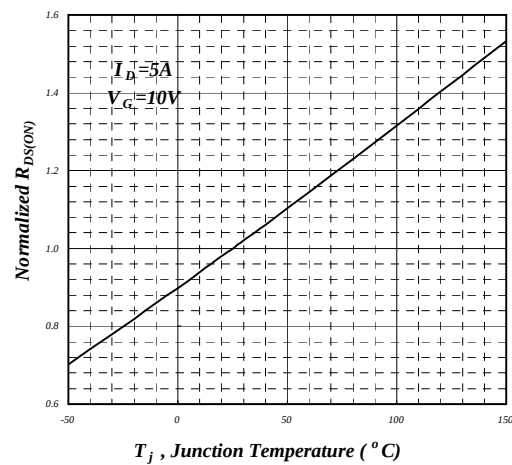


Fig 4. Normalized On-Resistance
v.s. Junction Temperature

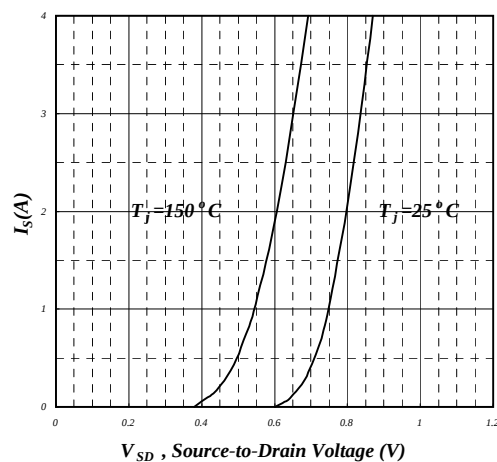


Fig 5. Forward Characteristic of
Reverse Diode

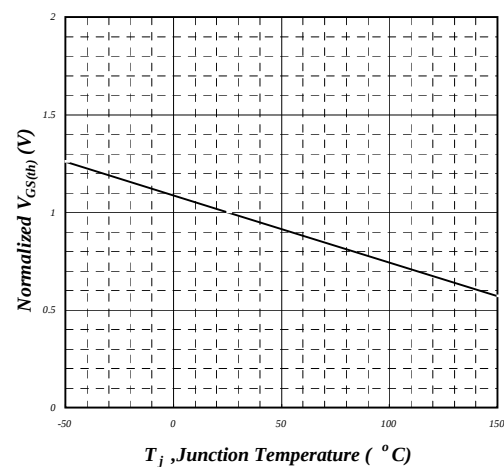


Fig 6. Gate Threshold Voltage v.s.
Junction Temperature



N-Channel

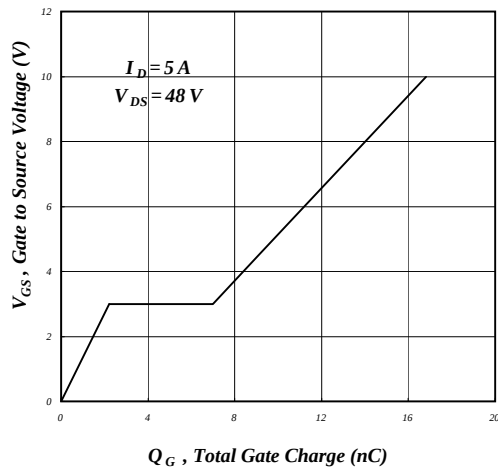


Fig 7. Gate Charge Characteristics

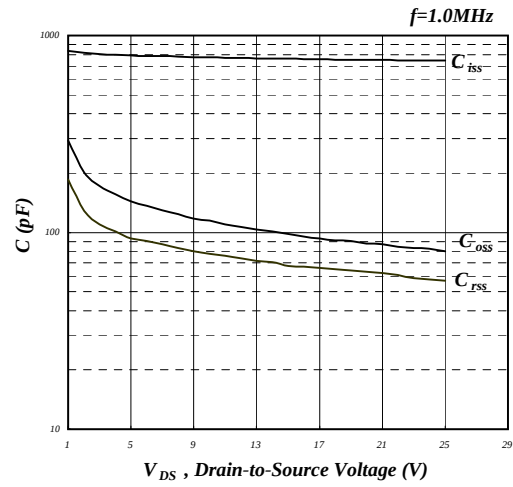


Fig 8. Typical Capacitance Characteristics

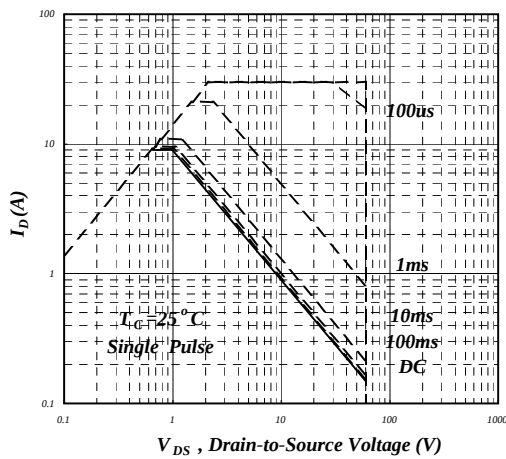


Fig 9. Maximum Safe Operating Area

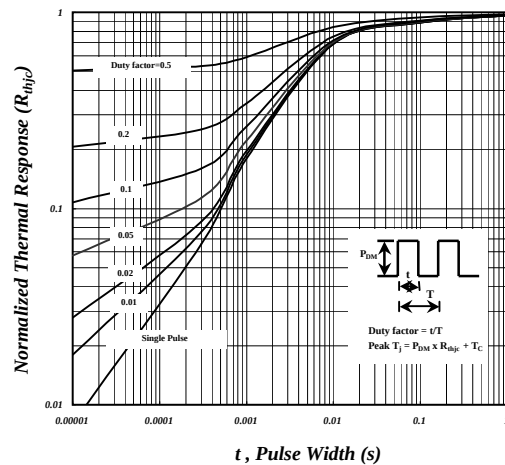


Fig 10. Effective Transient Thermal Impedance

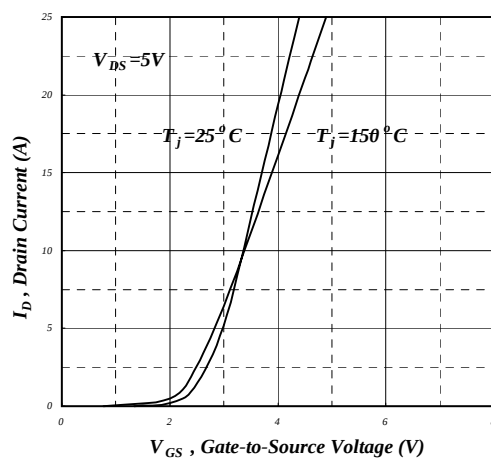


Fig 11. Transfer Characteristics

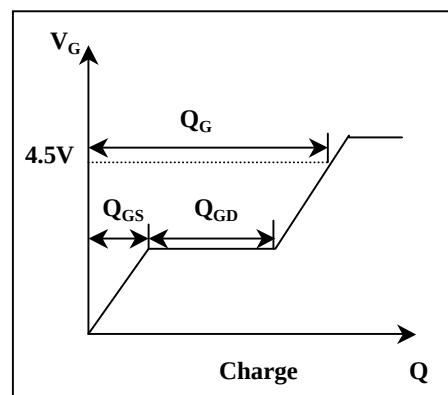


Fig 12. Gate Charge Waveform



AP4578GH

P-Channel

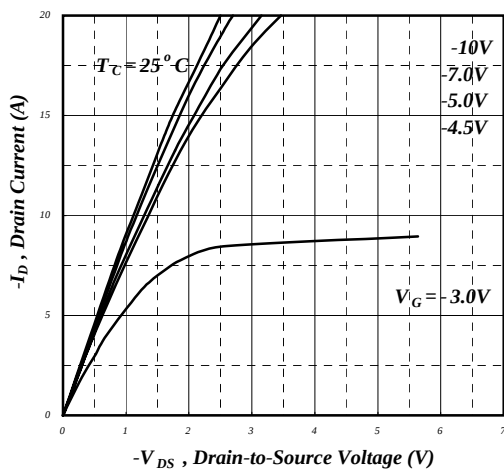


Fig 1. Typical Output Characteristics

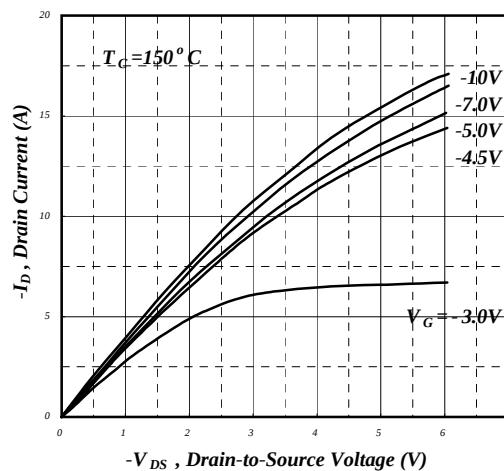


Fig 2. Typical Output Characteristics

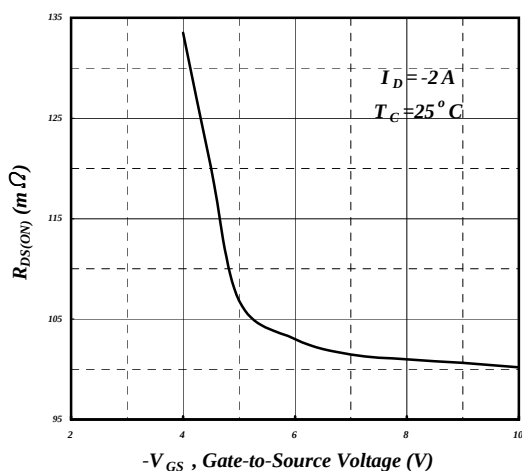


Fig 3. On-Resistance v.s. Gate Voltage

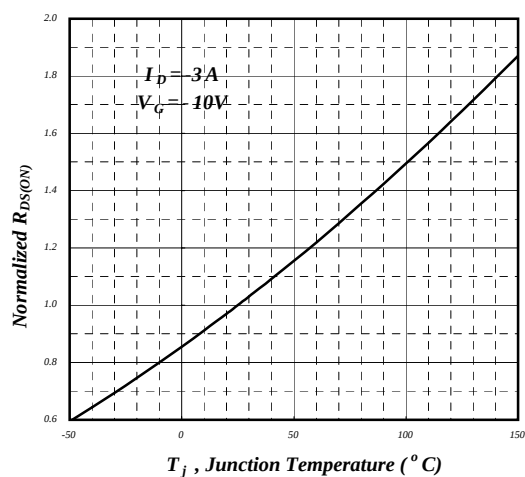


Fig 4. Normalized On-Resistance v.s. Junction Temperature

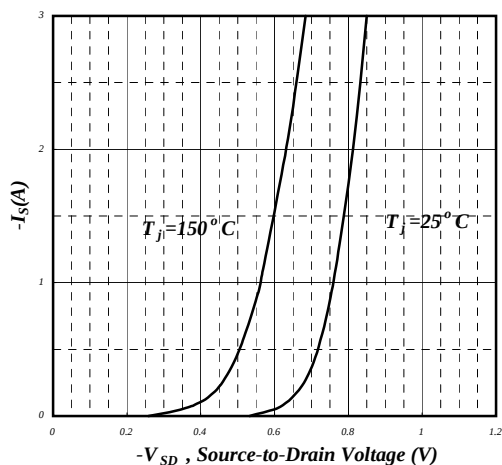


Fig 5. Forward Characteristic of Reverse Diode

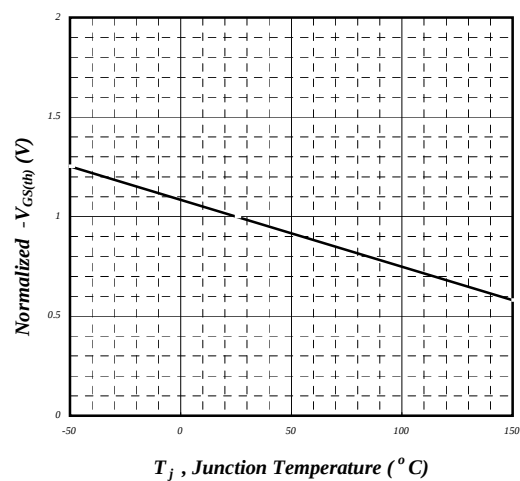


Fig 6. Gate Threshold Voltage v.s. Junction Temperature



P-Channel

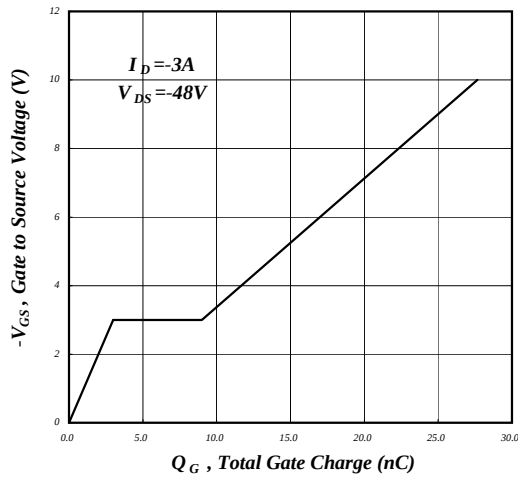


Fig 7. Gate Charge Characteristics

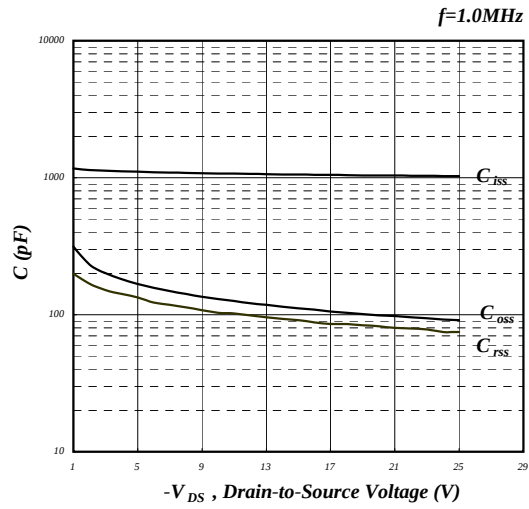


Fig 8. Typical Capacitance Characteristics

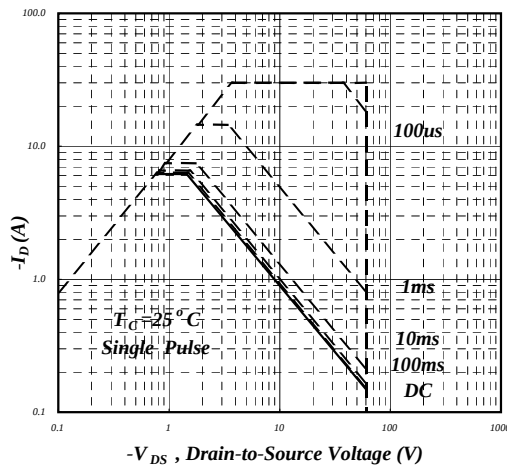


Fig 9. Maximum Safe Operating Area

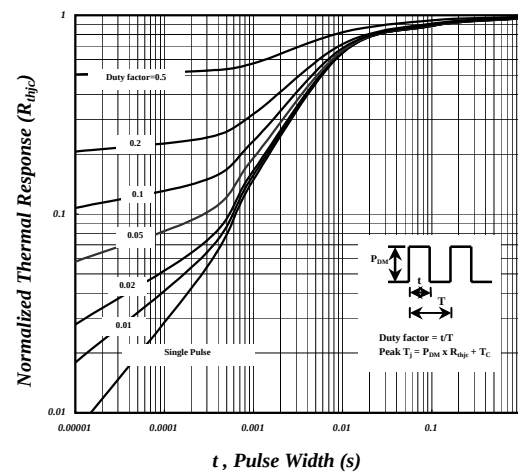


Fig 10. Effective Transient Thermal Impedance

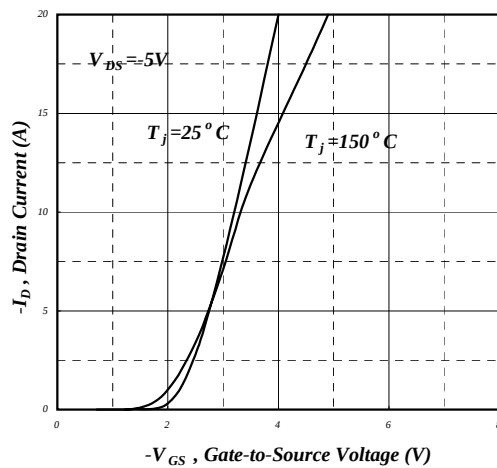


Fig 11. Transfer Characteristics

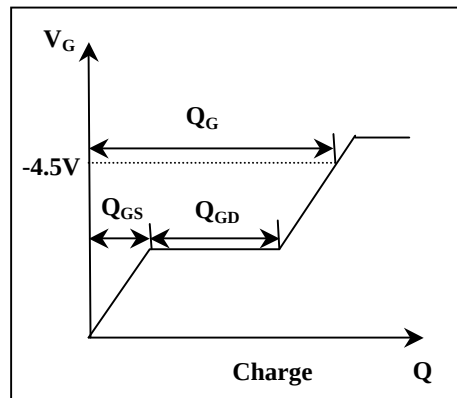


Fig 12. Gate Charge Waveform